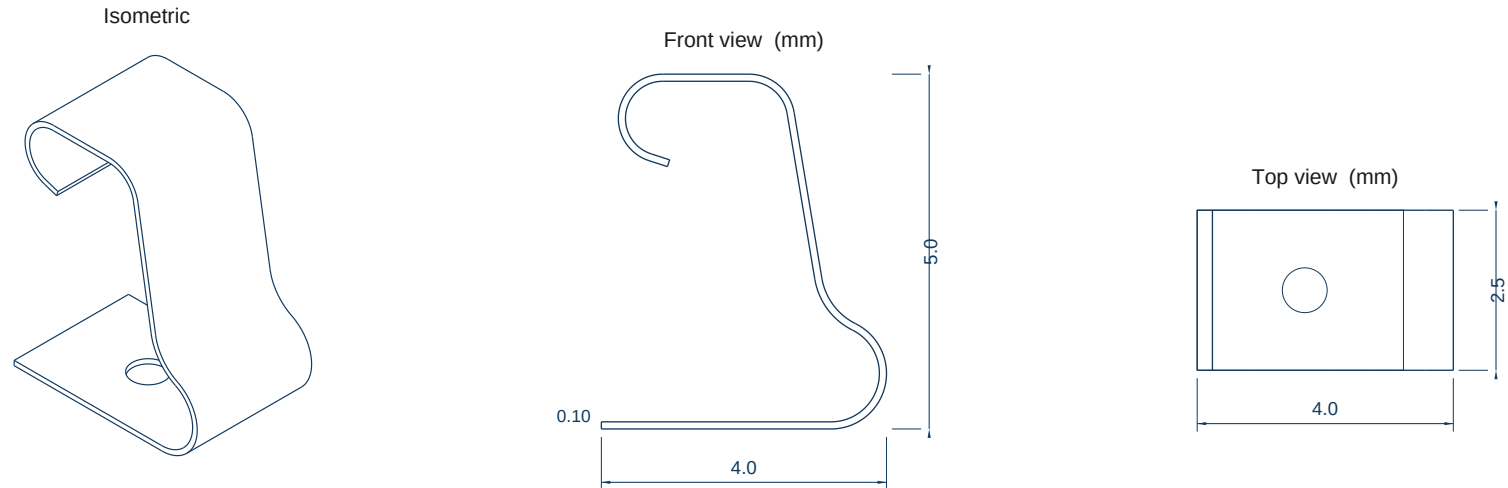




Type C-11 BC11-25040050

SMD EMI Spring Contact | Beryllium Copper | Units: mm



MECHANICAL

VALUE

Thickness	0.10 mm
Width	2.5 mm +/- 0.2
Length	4.0 mm +/- 0.2
Height	5.0 mm +/- 0.2
Form	base plate, S-bend riser, top arm, curled end hook
S-bend	R0.729 CL, 154 deg then R0.927 CL, 54 deg
Top bend	R0.594 CL, 81 deg
End hook	R0.572 CL, 162 deg
Riser	2.36 mm
Base hole	dia 0.70 mm at 1.68 from the base end
Developed length	12.34 mm
Material / plating	BeCu, Gold-plated (G)
Volume / mass	3.046 mm ³ 25.5 mg (BeCu)

PRODUCT DATA

VALUE

Mfr P/N	BC11-25040050G-SY (Au)
Brand	Seyunda
Description	SMD EMI Contact 4.0x2.5x5.0mm Au
Packaging	Tape & Reel (TR)
Category	Connectors, Interconnects
Sub-category	Contacts, Spring Loaded (Pogo Pins), and Pressure
Lifecycle / origin	Active / Taiwan, Republic of China
RoHS / REACH	RoHS3 Compliant / REACH Unaffected
ECCN / ESD	EAR99 / Static sensitive: Yes
Datasheet	seyunda.com/datasheet/Seyunda-SMD-Spring-Contacts-Datasheet.pdf
Product page	seyunda.com/type-c-11.html
File format	STEP AP214